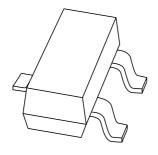
# **DISCRETE SEMICONDUCTORS**

# DATA SHEET



PBSS5320T 20 V, 3 A PNP low V<sub>CEsat</sub> (BISS) transistor

Product specification Supersedes data of 2002 Aug 08 2004 Jan 15





# 20 V, 3 A PNP low V<sub>CEsat</sub> (BISS) transistor

# **PBSS5320T**

#### **FEATURES**

- Low collector-emitter saturation voltage V<sub>CEsat</sub> and corresponding low R<sub>CEsat</sub>
- · High collector current capability
- High collector current gain
- Improved efficiency due to reduced heat generation.

### **APPLICATIONS**

- · Power management applications
- Low and medium power DC/DC convertors
- · Supply line switching
- · Battery chargers
- Linear voltage regulation with low voltage drop-out (LDO).

### **DESCRIPTION**

PNP low  $V_{\text{CEsat}}$  transistor in a SOT23 plastic package. NPN complement: PBSS4320T.

### **MARKING**

TYPE NUMBER	MARKING CODE(1)
PBSS5320T	ZH*

### Note

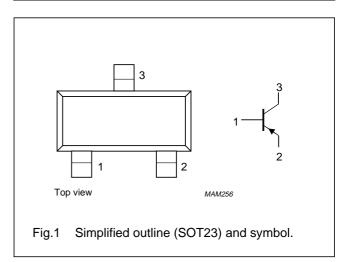
- 1. \* = p: Made in Hong Kong.
  - \* = t: Made in Malaysia.
  - \* = W: Made in China.

#### **QUICK REFERENCE DATA**

SYMBOL	PARAMETER	MAX.	UNIT
V <sub>CEO</sub>	collector-emitter voltage	-20	٧
I <sub>C</sub>	collector current (DC)	-2	Α
I <sub>CRP</sub>	repetitive peak collector current	-3	А
R <sub>CEsat</sub>	equivalent on-resistance	105	mΩ

## **PINNING**

PIN	DESCRIPTION	
1	base	
2	emitter	
3	collector	



### **ORDERING INFORMATION**

TYPE NUMBER	PACKAGE			
TIPE NOWIBER	NAME DESCRIPTION VERSION			
PBSS5320T	_	<ul> <li>plastic surface mounted package; 3 leads</li> </ul> SOT		

# 20 V, 3 A PNP low V<sub>CEsat</sub> (BISS) transistor

PBSS5320T

#### LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER CONDITIONS		MIN.	MAX.	UNIT
V <sub>CBO</sub>	collector-base voltage	open emitter	_	-20	V
V <sub>CEO</sub>	collector-emitter voltage	open base	_	-20	V
V <sub>EBO</sub>	emitter-base voltage	open collector	_	<b>-</b> 5	V
I <sub>C</sub>	collector current (DC)		_	-2	Α
I <sub>CRP</sub>	repetitive peak collector current	note 1	_	-3	Α
I <sub>CM</sub>	peak collector current	single peak	_	<b>-</b> 5	Α
I <sub>B</sub>	base current (DC)		_	-0.5	Α
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> ≤ 25 °C; note 2	_	300	mW
		T <sub>amb</sub> ≤ 25 °C; note 3	_	480	mW
		T <sub>amb</sub> ≤ 25 °C; note 4	_	540	mW
		T <sub>amb</sub> ≤ 25 °C; notes 1 and 2	_	1.2	W
T <sub>stg</sub>	storage temperature		-65	+150	°C
Tj	junction temperature		_	150	°C
T <sub>amb</sub>	operating ambient temperature		-65	+150	°C

### **Notes**

- 1. Operated under pulsed conditions: pulse width  $t_p \le 100$  ms; duty cycle  $\delta \le 0.25$ .
- 2. Device mounted on a printed-circuit board; single sided copper; tin plated; standard footprint.
- 3. Device mounted on a printed-circuit board; single sided copper; tin plated; mounting pad for collector 1 cm<sup>2</sup>.
- 4. Device mounted on a printed-circuit board; single sided copper; tin plated; mounting pad for collector 6 cm<sup>2</sup>.

#### THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R <sub>th(j-a)</sub>	thermal resistance from junction to	in free air; note 1	417	K/W
	ambient	in free air; note 2	260	K/W
		in free air; note 3	230	K/W
		in free air; notes 1 and 4	104	K/W

#### **Notes**

- Device mounted on a printed-circuit board; single sided copper; tin plated; standard footprint.
- 2. Device mounted on a printed-circuit board; single sided copper; tin plated; mounting pad for collector 1 cm<sup>2</sup>.
- 3. Device mounted on a printed-circuit board; single sided copper; tin plated; mounting pad for collector 6 cm<sup>2</sup>.
- 4. Operated under pulsed conditions: pulse width  $t_p \le 100$  ms; duty cycle  $\delta \le 0.25$ .

# 20 V, 3 A PNP low $V_{\text{CEsat}}$ (BISS) transistor

PBSS5320T

### **CHARACTERISTICS**

 $T_{amb}$  = 25 °C unless otherwise specified.

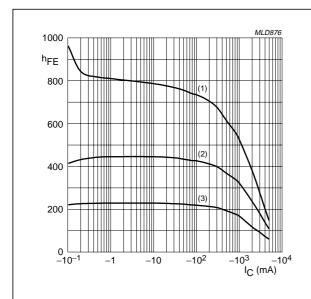
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I <sub>CBO</sub>	collector-base cut-off current	$V_{CB} = -20 \text{ V; } I_E = 0$	_	_	-100	nA
		$V_{CB} = -20 \text{ V; } I_E = 0; T_j = 150 ^{\circ}\text{C}$	_	_	-50	μΑ
I <sub>EBO</sub>	emitter-base cut-off current	$V_{EB} = -5 \text{ V}; I_C = 0$	_	_	-100	nA
h <sub>FE</sub>	DC current gain	$V_{CE} = -2 \text{ V}; I_{C} = -100 \text{ mA}$	220	_	_	
		$V_{CE} = -2 \text{ V}; I_{C} = -500 \text{ mA}$	220	_	_	
		$V_{CE} = -2 \text{ V; } I_{C} = -1 \text{ A; note 1}$	200	_	_	
		$V_{CE} = -2 \text{ V}; I_{C} = -2 \text{ A}; \text{ note 1}$	150	_	_	
		$V_{CE} = -2 \text{ V; } I_{C} = -3 \text{ A; note 1}$	100	_	_	
V <sub>CEsat</sub>	collector-emitter saturation	$I_C = -500 \text{ mA}; I_B = -50 \text{ mA}$	_	_	-70	mV
voltage	voltage	I <sub>C</sub> = -1 A; I <sub>B</sub> = -50 mA	_	_	-130	mV
	$I_C = -2 \text{ A}$ ; $I_B = -100 \text{ mA}$ ; note 1	_	_	-230	mV	
		$I_C = -2 \text{ A}$ ; $I_B = -200 \text{ mA}$ ; note 1	_	_	-210	mV
		$I_C = -3 \text{ A}$ ; $I_B = -300 \text{ mA}$ ; note 1	_	_	-300	mV
R <sub>CEsat</sub>	equivalent on-resistance	$I_C = -2 \text{ A}$ ; $I_B = -200 \text{ mA}$ ; note 1	_	75	105	mΩ
V <sub>BEsat</sub>	base-emitter saturation	$I_C = -2 \text{ A}$ ; $I_B = -100 \text{ mA}$ ; note 1	_	_	-1.1	V
	voltage	$I_C = -3 \text{ A}$ ; $I_B = -300 \text{ mA}$ ; note 1	_	_	-1.2	V
V <sub>BE(on)</sub>	base-emitter turn-on voltage	$V_{CE} = -2 \text{ V; } I_{C} = -1 \text{ A; note 1}$	-1.2	_	_	V
f <sub>T</sub>	transition frequency	$I_C = -100 \text{ mA}; V_{CE} = -5 \text{ V};$ f = 100 MHz	100	_	_	MHz
C <sub>c</sub>	collector capacitance	$V_{CB} = -10 \text{ V}; I_E = I_e = 0; f = 1 \text{ MHz}$	_	_	50	pF

# Note

1. Pulse test:  $t_p \le 300~\mu s;~\delta \le 0.02.$ 

# 20 V, 3 A PNP low $V_{CEsat}$ (BISS) transistor

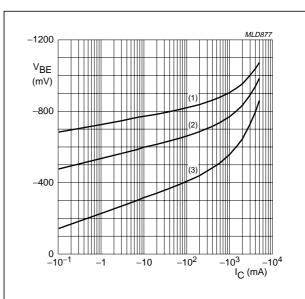
# PBSS5320T



 $V_{CE} = -2 V$ .

- (1) T<sub>amb</sub> = 150 °C.
- (2)  $T_{amb} = 25 \, ^{\circ}C$ .
- (3)  $T_{amb} = -55 \, ^{\circ}C$ .

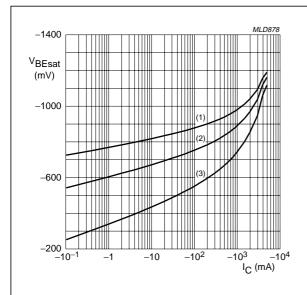
Fig.2 DC current gain as a function of collector current; typical values.



 $V_{CE} = -2 V$ .

- (1)  $T_{amb} = -55 \, ^{\circ}C$ .
- (2)  $T_{amb} = 25 \, ^{\circ}C$ .
- (3)  $T_{amb} = 150 \, ^{\circ}C$ .

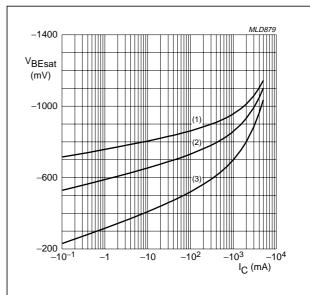
Fig.3 Base-emitter voltage as a function of collector current; typical values.



 $I_{\rm C}/I_{\rm B} = 10$ .

- (1)  $T_{amb} = -55 \, ^{\circ}C$ .
- (2)  $T_{amb} = 25 \, ^{\circ}C$ .
- (3)  $T_{amb} = 150 \, ^{\circ}C$ .

Fig.4 Base-emitter saturation voltage as a function of collector current; typical values.



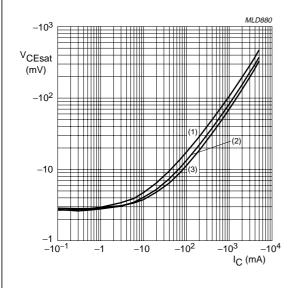
 $I_{\rm C}/I_{\rm B} = 20$ .

- (1)  $T_{amb} = -55 \, ^{\circ}C$ .
- (2)  $T_{amb} = 25 \, ^{\circ}C$ .
- (3)  $T_{amb} = 150 \,^{\circ}C$ .

Fig.5 Base-emitter saturation voltage as a function of collector current; typical values.

# 20 V, 3 A PNP low $V_{CEsat}$ (BISS) transistor

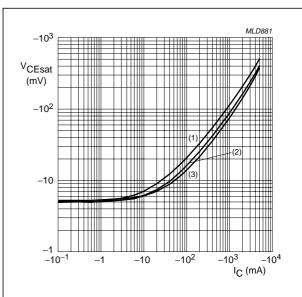
# PBSS5320T



 $I_{\rm C}/I_{\rm B} = 10.$ 

- (1)  $T_{amb} = 150 \, ^{\circ}C$ .
- (2)  $T_{amb} = 25 \, ^{\circ}C$ .
- (3)  $T_{amb} = -55 \, ^{\circ}C$ .

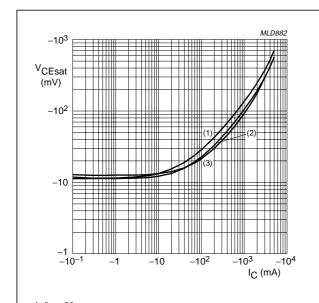
Fig.6 Collector-emitter saturation voltage as a function of collector current; typical values.



 $I_{\rm C}/I_{\rm B}=20.$ 

- (1)  $T_{amb} = 150 \, ^{\circ}C$ .
- (2)  $T_{amb} = 25 \, ^{\circ}C$ .
- (3)  $T_{amb} = -55 \, ^{\circ}C$ .

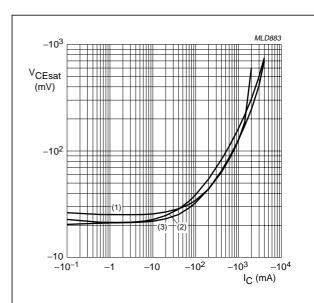
Fig.7 Collector-emitter saturation voltage as a function of collector current; typical values.



 $I_{\rm C}/I_{\rm B} = 50.$ 

- (1) T<sub>amb</sub> = 150 °C.
- (2)  $T_{amb} = 25 \, ^{\circ}C$ .
- (3)  $T_{amb} = -55 \, ^{\circ}C$ .

Fig.8 Collector-emitter saturation voltage as a function of collector current; typical values.



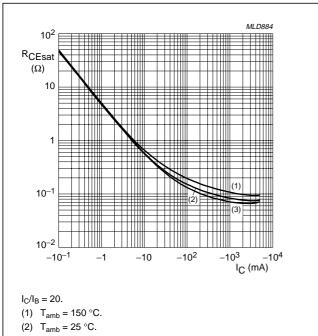
 $I_{\rm C}/I_{\rm B} = 100.$ 

- (1)  $T_{amb} = 150 \, ^{\circ}C$ .
- (2)  $T_{amb} = 25 \, ^{\circ}C$ .
- (3)  $T_{amb} = -55 \, ^{\circ}C$ .

Fig.9 Collector-emitter saturation voltage as a function of collector current; typical values.

# 20 V, 3 A PNP low $V_{\text{CEsat}}$ (BISS) transistor

PBSS5320T



(3)  $T_{amb} = -55 \, ^{\circ}C$ .

Fig.10 Equivalent on-resistance as a function of collector current; typical values.

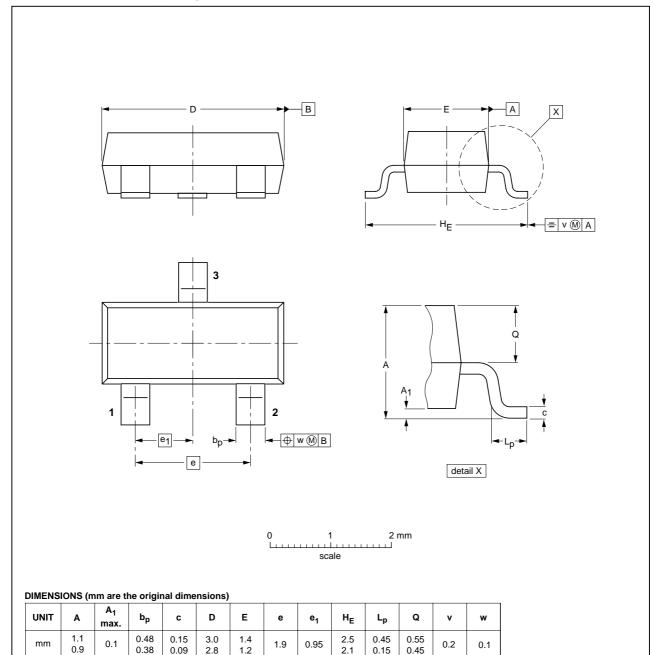
20 V, 3 A PNP low  $V_{CEsat}$  (BISS) transistor

PBSS5320T

# **PACKAGE OUTLINE**

# Plastic surface mounted package; 3 leads

SOT23



OUTLINE	REFERENCES			EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	EIAJ		PROJECTION ISSUE DA	
SOT23		TO-236AB				<del>-97-02-28</del> 99-09-13

20 V, 3 A PNP low V<sub>CEsat</sub> (BISS) transistor

PBSS5320T

#### **DATA SHEET STATUS**

LEVEL	DATA SHEET STATUS <sup>(1)</sup>	PRODUCT STATUS(2)(3)	DEFINITION
I	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
II	Preliminary data	Qualification	This data sheet contains data from the preliminary specification. Supplementary data will be published at a later date. Philips Semiconductors reserves the right to change the specification without notice, in order to improve the design and supply the best possible product.
III	Product data	Production	This data sheet contains data from the product specification. Philips Semiconductors reserves the right to make changes at any time in order to improve the design, manufacturing and supply. Relevant changes will be communicated via a Customer Product/Process Change Notification (CPCN).

#### **Notes**

- 1. Please consult the most recently issued data sheet before initiating or completing a design.
- 2. The product status of the device(s) described in this data sheet may have changed since this data sheet was published. The latest information is available on the Internet at URL http://www.semiconductors.philips.com.
- 3. For data sheets describing multiple type numbers, the highest-level product status determines the data sheet status.

#### **DEFINITIONS**

**Short-form specification** — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

Application information — Applications that are described herein for any of these products are for illustrative purposes only. Philips Semiconductors make no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

#### **DISCLAIMERS**

Life support applications — These products are not designed for use in life support appliances, devices, or systems where malfunction of these products can reasonably be expected to result in personal injury. Philips Semiconductors customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips Semiconductors for any damages resulting from such application.

Right to make changes — Philips Semiconductors reserves the right to make changes in the products - including circuits, standard cells, and/or software - described or contained herein in order to improve design and/or performance. When the product is in full production (status 'Production'), relevant changes will be communicated via a Customer Product/Process Change Notification (CPCN). Philips Semiconductors assumes no responsibility or liability for the use of any of these products, conveys no licence or title under any patent, copyright, or mask work right to these products, and makes no representations or warranties that these products are free from patent, copyright, or mask work right infringement, unless otherwise specified.

# Philips Semiconductors – a worldwide company

#### **Contact information**

For additional information please visit http://www.semiconductors.philips.com. Fax: +31 40 27 24825 For sales offices addresses send e-mail to: sales.addresses@www.semiconductors.philips.com.

© Koninklijke Philips Electronics N.V. 2004

SCA76

All rights are reserved. Reproduction in whole or in part is prohibited without the prior written consent of the copyright owner.

The information presented in this document does not form part of any quotation or contract, is believed to be accurate and reliable and may be changed without notice. No liability will be accepted by the publisher for any consequence of its use. Publication thereof does not convey nor imply any license under patent- or other industrial or intellectual property rights.

Printed in The Netherlands

R75/02/pp10

Date of release: 2004 Jan 15

Document order number: 9397 750 12441

Let's make things better.

Philips Semiconductors



